

# Model: BGi-100 Automatic Glue Tape Lamination



# **Suitable for BIOMETRIC sensor lamination**

# Features & description

The BGi100 is an automatic glue tape lamination equipment (dimension of reel: 35mm width).

- Stand alone equipment with automatic hotmelt and chip feeding
- Screen touch interface (30 programs memorized)

# Advantages

- Compact and easy with a throughput of 10 000 units per hour
- Easy adjustment of time, pressure and temperature parameters

## Option BGi100a

■ BGi100a is the punch tool allowing to punch the hotmelt tape before lamination (glob top at the back of the chips or biometric sensor)

#### Dimensions and weights

Width: 1480mmDepth: 480mmHeight: 1650mmWeight: 85kg to 95kg

### Throughput

Up to 10 000 units/hour

#### **Facilities**

Power: 100-240V AC

Frequency: 50-60Hz single phasePower consumption: 350W maximumPneumatic characteristics: 6 bars

#### **Environmental conditions**

Operating temperature: +10°C to +40°C

